



Pool boiling heat transfer of porous structures with reentrant cavities



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ABSTRACT

Porous structures with reentrant cavities (PS-RC) were proposed and developed for pool boiling cooling systems. They were totally constructed by sintered copper powder via a solid-state sintering method. They featured 12 parallel Ω -shaped reentrant channels with large circular cavities inside and narrow exit slots upside. Their pool boiling heat transfer performance was systematically explored using two coolants (deionized water and ethanol) in different liquid subcoolings (3–30 °C) at atmospheric pressure. Solid structures with the same reentrant cavities were prepared and tested for comparison. Experimental results revealed that the porous structures with reentrant cavities presented a significant reduction of wall superheat for the onset of nucleate boiling (ONB), and a maximum 3 and 5.3 folds enhancement in pool boiling heat transfer in water and ethanol tests, respectively. The above enhancement was associated with the merits of PS-RC in the enlargement of heat transfer area, increase in active nucleation sites and improvement of liquid replenishment. Besides, the heat transfer curves together with visualization results showed that three boiling regimes dominated in the PS-RC with the increase in heat fluxes, i.e., isolated bubbles nucleate boiling, fully developed nucleate boiling and bubbles coalescence nucleate boiling. The PS-RC was able to maintain sufficient liquid replenishment and efficient surface rewetting even at high heat fluxes, which help to avoid the fast deterioration of heat transfer at moderate to high heat fluxes.

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1. Introduction

Urgent demand for efficient cooling of microelectronic chips, nuclear power plants and laser generators has spurred the development of enhanced boiling techniques [1]. Utilizing latent heat exchange, pool boiling is widely recognized as an effective method to dissipate high heat fluxes from a limited space, and simultaneously maintain relatively uniform surface temperatures. Various boiling enhancement methods have been proposed and implemented in the last few decades [2–3], which address one or more aspects of boiling to improve heat transfer performance. Except the newly emerged nano-related means, e.g., nano structures [4–5] and nanofluids [6], common and stable enhancement methods can be roughly categorized as two directions.

One is to form reentrant cavities or tunnels on the boiling surface using the machining techniques. The reentrant cavities or tunnels have been widely known to act as vapor traps during nucleate boiling, which facilitate the increase of stable bubble nucleation sites and thus enhanced pool boiling heat transfer [7]. Their wide

utilization in the outside tubes of commercial heat exchangers, such as Gewa-T tubes [8], Thermoexcle-E tubes [9], and Turbo-B tubes [10], has promoted the third-generation heat transfer technology [11]. The merits of reentrant cavities or tunnels have been demonstrated repeatedly, such as by Chien and Webb [9], Chen et al. [12] and recently, Das et al. [13]. Moreover, Nakayama et al. [14] introduced an enhancement structure consisting of interconnected tunnels with small pores connecting the tunnels and pool liquid. Experimental results demonstrated an 80–90% reduction of wall superheat to transfer the same heat flux compared to a plain surface. A suction-evaporation model was also given to interpret the bubble behaviors inside the enhanced surfaces. Ramaswamy et al. [15] fabricated interconnected microchannels using wafer dicing and wet etching method on either side of silicon substrate and aligned at an angle of 90° to each other. Square pores or tunnels formed at the intersection of channels, which contributed to the bubble nucleation considerably. Honda et al. [16] fabricated micro-pin-fins on a silicon chip using a dry etching technique, and found that the micro-pin-finned chips showed a considerable heat transfer enhancement and 1.9–2.3 times improvement in critical heat flux (CHF) over the smooth chip.

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